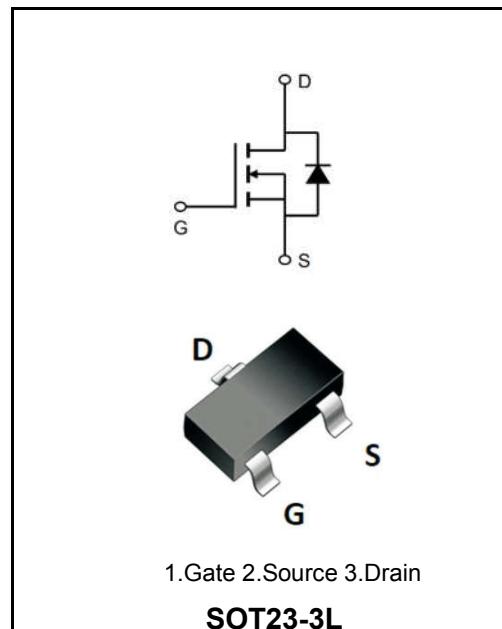


30V N-CHANNEL ENHANCEMENT MODE MOSFET
MAIN CHARACTERISTICS

I_D	13A
V_{DSS}	30V
$R_{DS(on)-typ}(@V_{GS}=10V)$	< 15mΩ (Type: 11 mΩ)


Marking Code

YFW3410MI	X10V-34
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Maximum Ratings at $T_c=25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbols	Value	Units
Drain-Source Voltage	V_{DS}	30	V
Gate - Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS} @ 10V^1$ @ $T_c=25^\circ\text{C}$	I_D	13	A
Continuous Drain Current, $V_{GS} @ 10V^1$ @ $T_c=100^\circ\text{C}$	I_D	8.5	A
Pulsed Drain Current ²	I_{DM}	39	A
Single Pulse Avalanche Energy ³	E_{AS}	11	mJ
Total Power Dissipation ⁴ @ $T_c=25^\circ\text{C}$	P_D	42	W
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C
Thermal Resistance Junction-ambient ¹	$R_{\theta JA}$	125	°C/W
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	3	°C/W

Maximum Ratings at T_c=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	BV _{DSS}	30	32	-	V
BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA	ΔBV _{DSS/ΔTJ}	-	0.0193	-	V/°C
Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =30A	R _{DS(ON)}	-	11	15	mΩ
	V _{GS} =4.5V, I _D =15A		-	18	25	
Gate -Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	V _{GS(th)}	1.2	1.6	2.5	V
V _{GS(th)} Temperature Coefficient		ΔV _{GS(th)}	-	-3.97	-	mV/°C
Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C	I _{DSS}	-	-	1	μA
	V _{DS} =24V , V _{GS} =0V , T _J =55°C		-	-	5	
Gate –Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	I _{GSS}	-	-	±100	nA
Forward Transconductance	V _{DS} =5V , I _D =30A	g _{fs}	-	34	-	S
Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	R _g	-	1.8	-	Ω
Total Gate Charge(4.5V)	V _{DS} =15V V _{GS} =4.5V I _D =15A	Q _g	-	9.8	-	nC
Gate-Source Charge		Q _{gs}	-	4.2	-	
Gate-Drain Charge		Q _{gd}	-	3.6	-	
Turn-on delay time	V _{DD} =15V V _{GS} =10V R _G =3.3Ω I _D =15A	t _{d(on)}	-	4	-	ns
Rise Time		T _r	-	8	-	
Turn-Off Delay Time		t _{d(OFF)}	-	31	-	
Fall Time		t _f	-	4	-	
Input Capacitance	V _{DS} =15V V _{GS} =0V f=1.0MHz	C _{iss}	-	940	-	pF
Output Capacitance		C _{oss}	-	131	-	
Reverse Transfer Capacitance		C _{rss}	-	109	-	
Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	I _s	-	-	43	A
Pulsed Source Current ^{2,5}		I _{SM}	-	-	112	A
Diode Forward Voltage ²	V _{GS} =0V , I _s =1A , T _J =25°C	V _{SD}	-	-	1	V
Reverse Recovery Time	IF=30A , dl/dt=100A/μs , T _J =25°C	t _{rr}	-	8.5	-	ns
Reverse Recovery Charge		Q _{rr}	-	2.2	-	nC

Note :

- 1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3、The power dissipation is limited by 150°C junction temperature
- 4、The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation.

Ratings and Characteristic Curves

Typical Characteristics

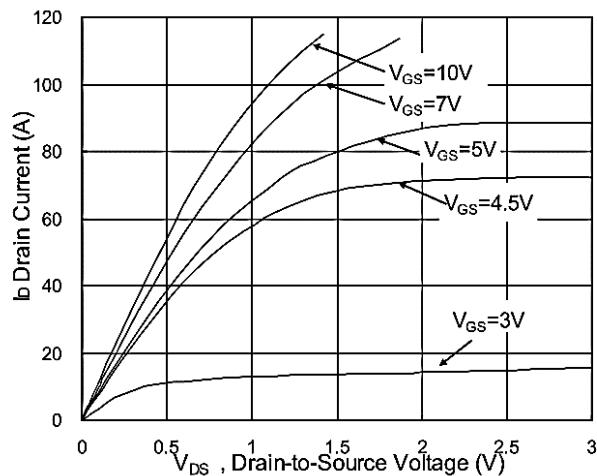


Fig.1 Typical Output Characteristics

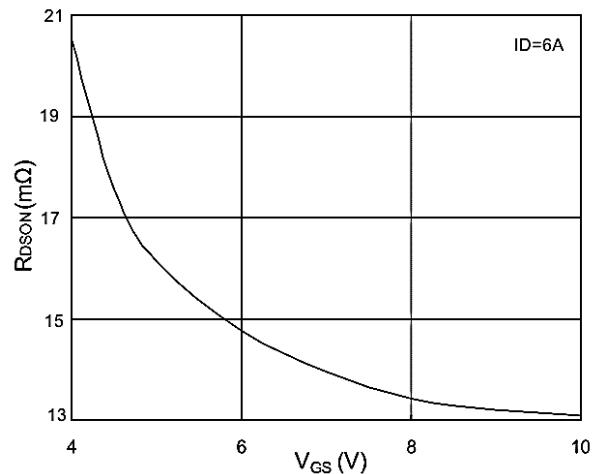


Fig.2 On-Resistance vs. G-S Voltage

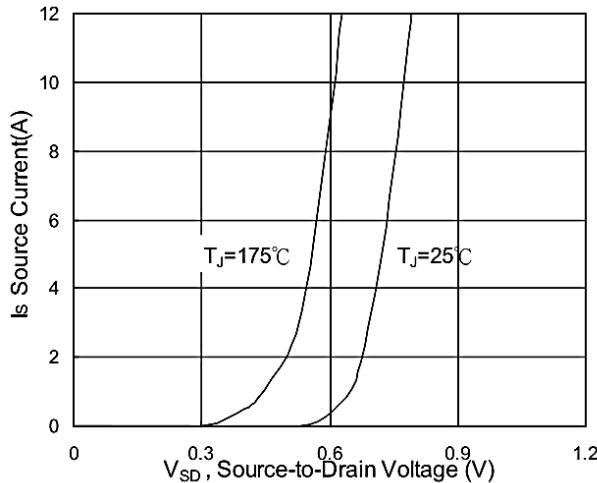


Fig.3 Forward Characteristics of Reverse

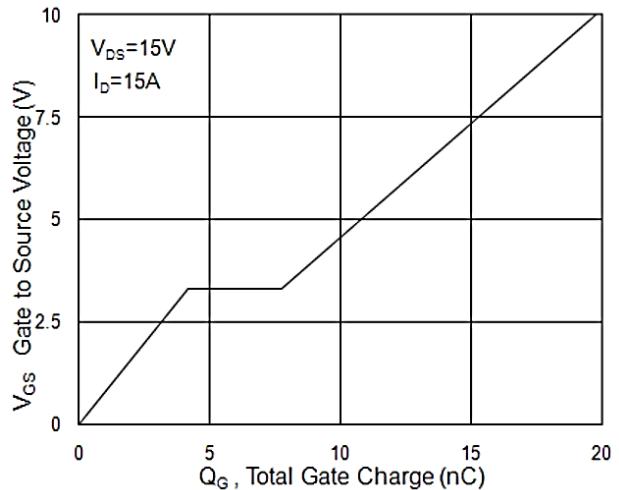


Fig.4 Gate-Charge Characteristics

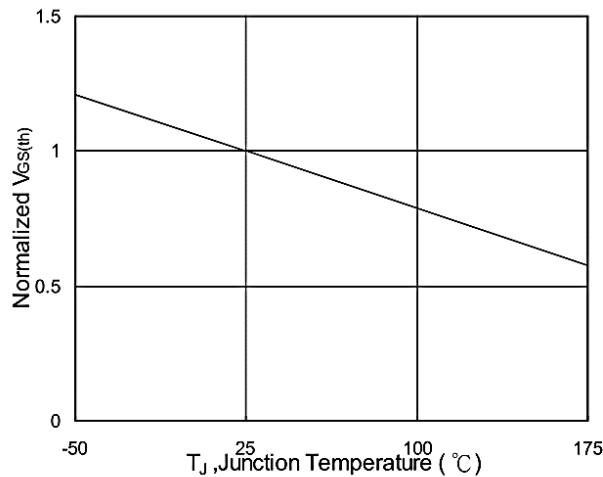


Fig.5 Normalized V_{GS(th)} vs. T_J

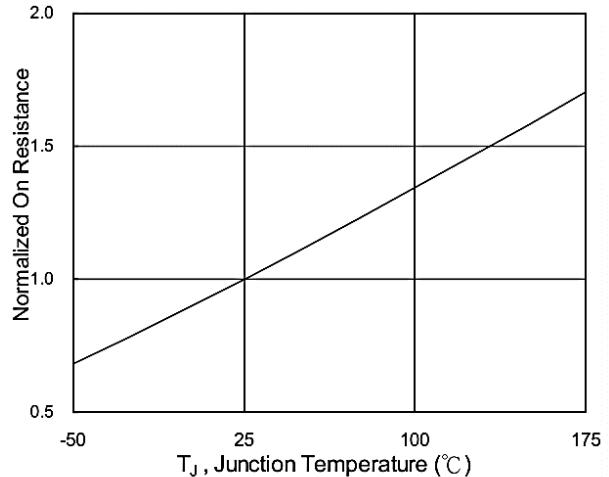
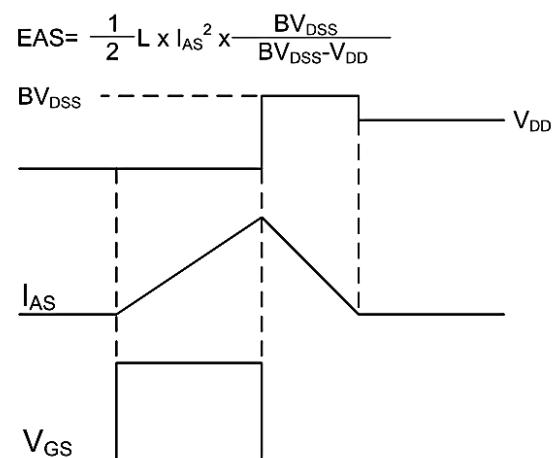
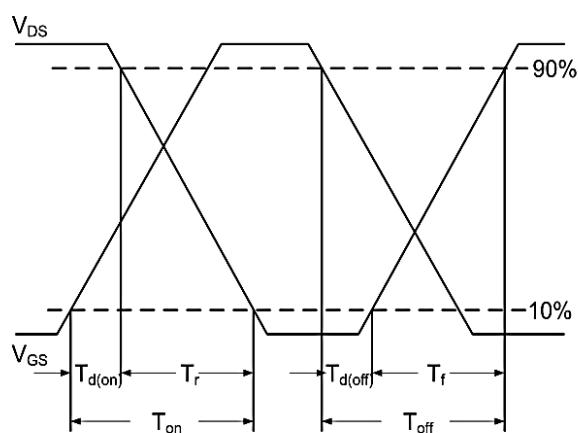
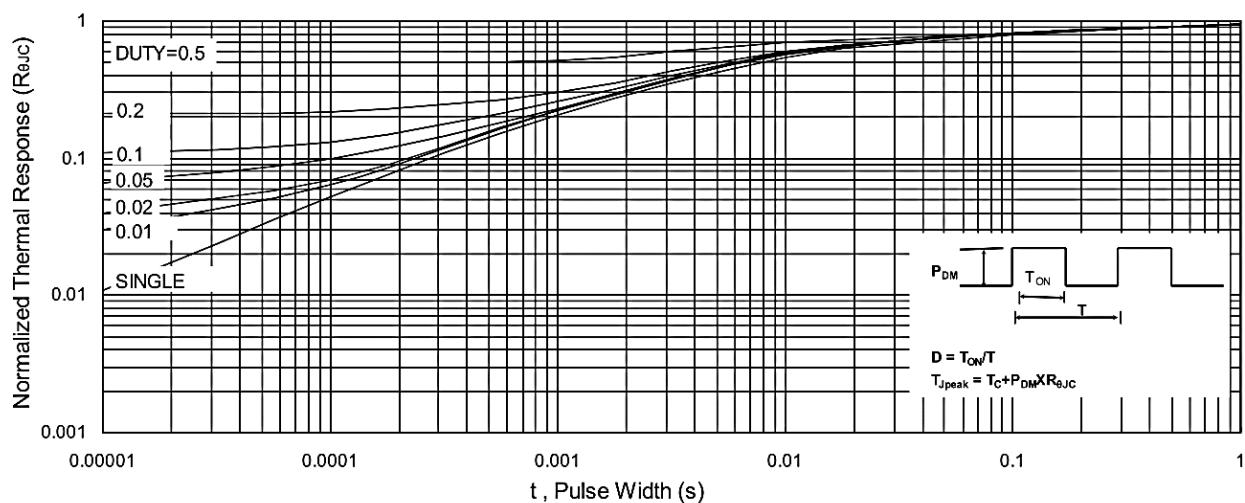
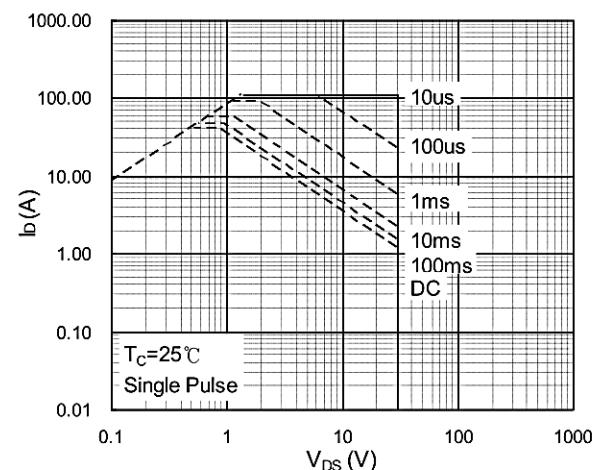
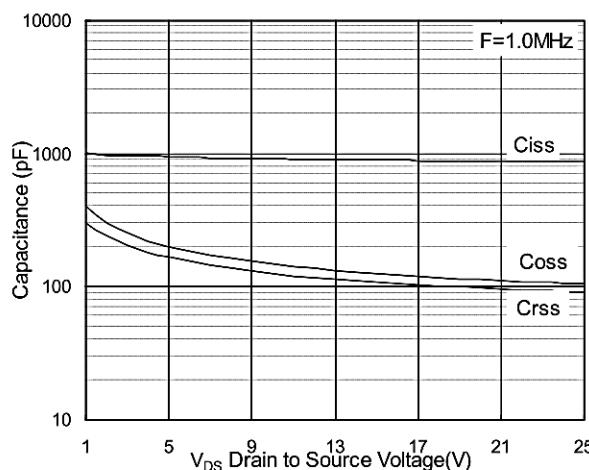


Fig.6 Normalized R_{DSON} vs. T_J

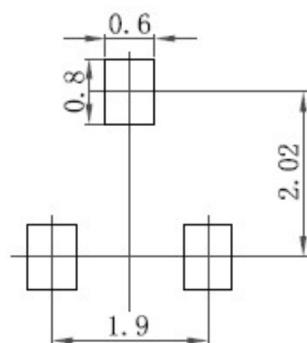
Ratings and Characteristic Curves


Ordering information

Package	Packing Description	Base Quantity	Packing Quantity
SOT23-3L	Tape/Reel,7"reel	3000pcs/Reel	24000PCS/Box 120000PCS/Carton

Package Dimensions
SOT23-3L

Dim.	Millimeter (mm)		mil	
	Min.	Max.	Min.	Max.
A	1.05	1.25	41	49.2
A1		0.10		3.93
A2	1.05	1.15	41	45
b	0.30	0.50	12	20
c	0.10	0.20	3.93	7.9
D	2.82	3.02	111	119
E	1.50	1.70	59	67
E1	2.65	2.95	104	116
e		0.95		37.4
e1	1.80	2.00	71	78
L	0.30	0.066	12	26
Θ			8°	

The recommended mounting pad size


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